

## WITH IN SITU RHEED

#### THIN FILM GROWTH WITH ATOMIC PRECISION

TSST Advanced Pulsed Laser Deposition systems with in situ RHEED are state-of-the-art, highly flexible PLD systems for thin film research at atomic level, ideally suited and field proven for research on a large variety of materials including complex oxides.

#### **EXPERIENCE**

Closely collaborating with the University of Twente, TSST integrates fundamental knowledge on thin film growth and parameter optimisation in its designs of the PLD systems. Therefore, the systems offer full flexibility in altering and investigating the essential parameters such as gas mixtures, process pressure, fluence, target-to-substrate distance and substrate temperature with the highest possible accuracy.

#### **SERVICE**

TSST PLD systems are installed and acceptance tested on site by experienced TSST engineers. A full user training is part of the installation procedure, during which monolayer growth control using RHEED is demonstrated.

TSST engineers are always available for support, while our software with extensive data logging supports quick and effective remote service.

TSST is specialised in customised products.
With almost 20 years of experience TSST is able to offer individually designed systems and components adapted to the need of our customer. This includes preparing a system for future upgrades.

#### System characteristics

- Thin film growth of highest quality complex materials
- Single monolayer growth control with RHEED
- Fully customised design, including adaptation to a specific lab layout
- Remote support, service and on site training by TSST engineers
- Down to 5.0x10<sup>-10</sup> mbar base pressure
- Up to 1100°C growth temperature
- Up to 6 odd shaped targets for heterostructure growth



# **Advanced Pulsed Laser Deposition**

\* optional

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#### **VACUUM CHAMBER**



Chamber shape	Cylindrical, spherical*
Base pressure	<10 <sup>-8</sup> mbar, down to 5.0x10 <sup>-10</sup> mbar*
Pumping	Turbo (700l/s), TSP*, Ion getter*
Bakeout*	Heating tape, bakeout tent
Process gases, pressure	O <sub>2</sub> , Ar, N <sub>2</sub> , O <sub>3</sub> * automated up/downstream pressure control

#### **HEATER STAGE**



Infrared laser	Up to 1100°C, 10x10mm substrates
Radiation	Up to 1000°C, <1", <2"* substrates
Resistive	Up to 900°C, <1" substrates
Movement	X, Y, Z, tilt, azimuth movement
Shutter	Allows use of RHEED while closed

#### TARGET STAGE



Movement	X, Y, Z, scanning stage, spinning*
Amount of targets	Up to 6
Targetsize	Odd shaped up to 1", 2"*
Transfer	Individual or whole carousel

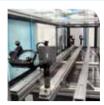
#### HIGH PRESSURE RHEED



Electron gun specifications	30kV, higher voltages*
Operational process pressure	Up to 0.5 mbar
Pumping	Differentially pumped
Vibrational limiting solutions	

Optimal signal-to-noise by stabilisation solutions for magnetic effects of the heater

#### **OPTICS**



Fluence	Full range flexibility for complex materials and metal ablation
Fluence control	Manual or with attenuator*
Spotsize	1.0-3.0 mm², homogeneous fluence by mask imaging
Safety	Fully enclosed, UV tight, visually transparant

### LOADLOCK



Pumping	Turbo (>70l/s)
Base pressure	<10 <sup>-5</sup> mbar
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Heater and target storage\*

#### TSST CONTROL SOFTWARE

Full manual to automated control, including growth recipes and parameter logging





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